



Case Study Opportunities for Investigations in Energy Efficiency

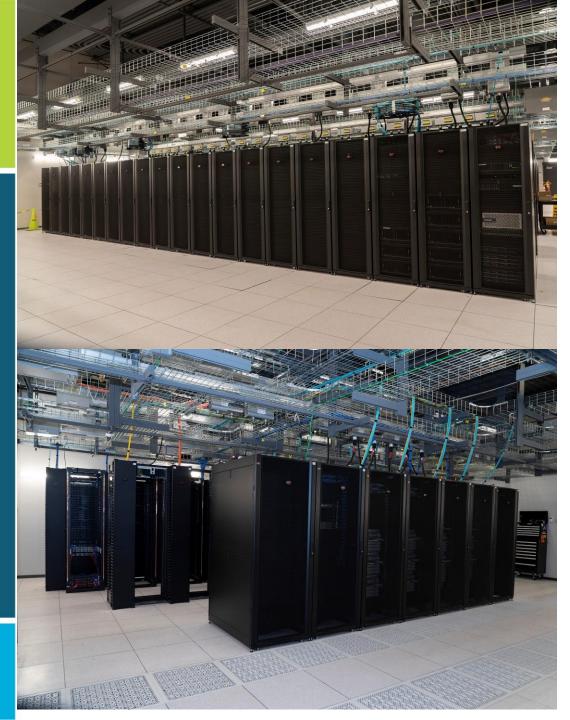
Imran Latif March 18, 2024



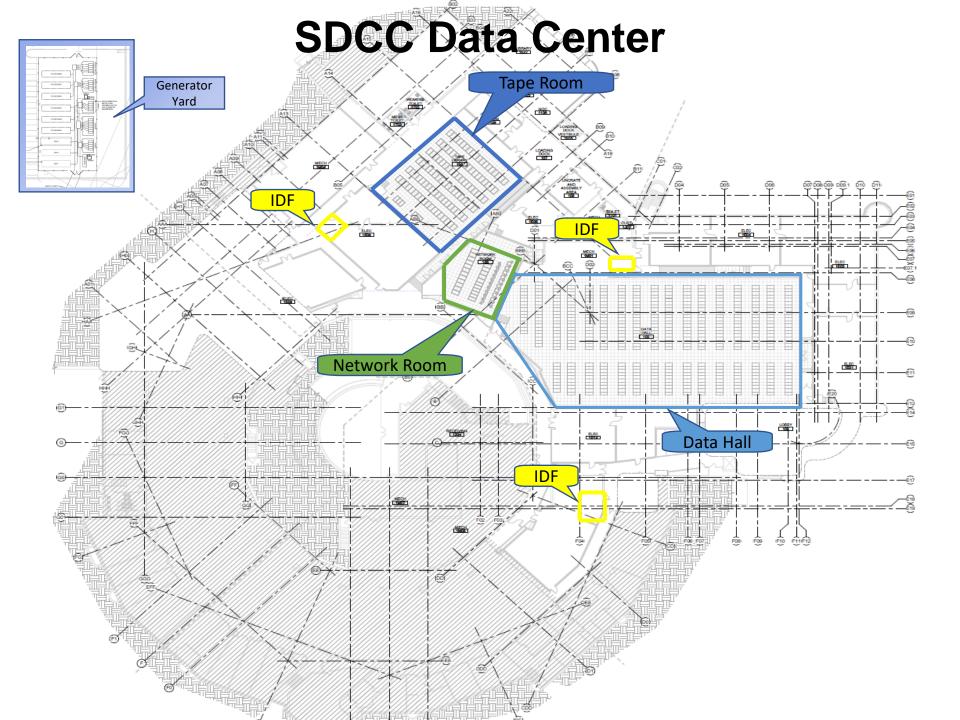


SDCC Data Center Building 725 (Features)

- √ 50,000 gross sq.ft. Built in 2021 \$85M cost to build
- ✓ Energy efficient with 1.2 target PUE
- √ 18,000 sq.ft IT space for computing/storage
- ✓ Power and cooling infrastructure outside of IT rooms
- √ ~500 physical rack capacity, standard 42U, 19 in racks
- √ 3.6MW current power available with 9.6MW ultimate build out
- √ 1.2MW of power and cooling blocks installation- scalable approach
- ✓ Chilled water available for high density CPU/GPU

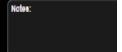




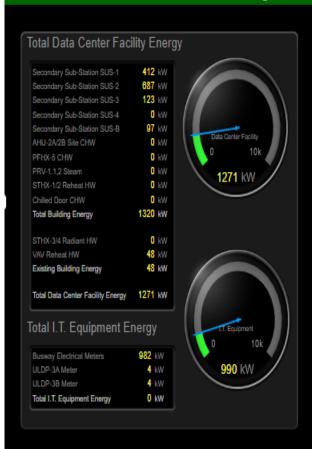


Data Center PUE

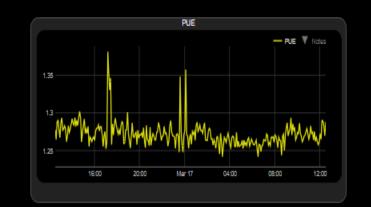




Power Usage Effectiveness (PUE) and Data Center infrastructure Efficiency (DCiE)



PUE 1.3 DCiE 78





PUE History	
Today	1.3
Previous Day	1.3
Month-to-Date	1.3
Previous Month	1.3
Quarter-to-Date	1.3
Previous Quarter	1.3
Year-to-Date	1.3
Previous Year	1.4

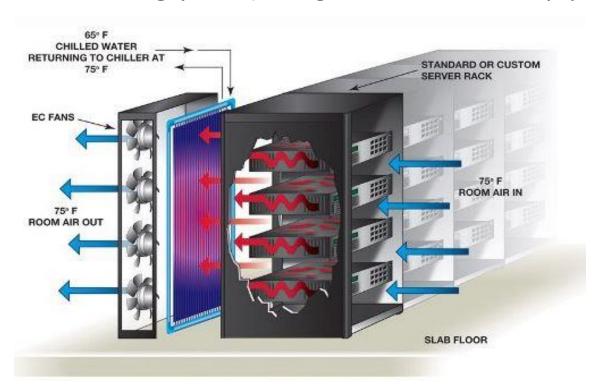
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RDHx – Opportunities for Investigations in Energy Efficiency

RDHx turns a 19" rack into a miniature datacenter enables experimentation with cooling infrastructure and environmental conditions

Simulate higher ambient room temperature

- Effects on server performance and power consumption
- Effects on the cooling system operating conditions and ultimately system efficiency



Typical Rear Door Heat Exchanger RDHx

Case study Setup

- Standard 42U 19" racks with up to 30KW load per rack
 - (26) 1U Dell Power Edge R640 Nodes and one (1U) Networking Switch
- Bulk of the sensible cooling provided by rear door heat exchangers 60°F chilled water input
- 75°F ambient dry bulb temperature and 40%-50% relative humidity in the MDH
- Controlled RDHx fan speed to modulate server temperature (simulate increased ambient temperature)
- ATLAS HEPScore23Beta benchmark workload generator
- Monitored
 - Rack power consumption (server+RDHx)
 - Server air inlet temperature and RDHx air inlet and outlet temperatures
 - Rack water supply control valve (controls water flow)
 - Server benchmark performance

Dell EMC PowerEdge R640 Technical Specs for the Allowable Ambient Temp

Table 31. Standard operating temperature specifications Standard operating temperature Specifications Continuous operation (for altitude less than 950m or 3117ft) 10°C to 35°C (50°F to 95°F) with no direct sunlight on the equipment.

Table 32. Expanded operating temperature specifications

Expanded operating temperature	Specifications
Continuous operation	5°C to 40°C at 5% to 85% RH with 29°C dew point. NOTE: Outside the standard operating temperature (10°C to 35°C), the system can operate continuously in temperatures as low as 5°C and as high as 40°C. For temperatures between 35°C and 40°C, de- rate maximum allowable temperature by 1°C per 175 m above 950 m (1°F per 319 ft).
≤ 1% of annual operating hours	-5°C to 45°C at 5% to 90% RH with 29°C dew point. NOTE: Outside the standard operating temperature (10°C to 35°C), the system can operate down to -5°C or up to 45°C for a maximum of 1% of its annual operating hours. For temperatures between 40°C and 45°C, de- rate maximum allowable temperature by 1°C per 125 m above 950 m (1°F per 228 ft).

Table 2.1 2021 Thermal Guidelines for Air Cooling— SI Version (I-P Version in Appendix B)

		Si version (I-P ve	131011	iii Appei	iuix b)			
	Equ	ipment Environment	Specific	ations for	Air Cooli	ng		
	Product Operation ^{b,c}					Product Power Off ^{c,d}		
Class ^a	Dry-Bulb Temp. ^{e,g} , °C	Humidity Range, Noncond. ^{h, i, k, i, n}	Max. Dew Point ^k , °C	Max. Elev. ^{e,j,m} , m	Max. Rate of Change ^f , °C/h	Dry- Bulb Temp., RH ^k , °C %		
	Recommended (suitable for Classes A1 to A4; explore data center metrics in this book for conditions outside this range.)							
A1 to A4	18 to 27	-9°C DP to 15°C DP and 70% rh ⁿ or 50% rh ⁿ						
Allowa	able							
A1	15 to 32	–12°C DP and 8% rh to 17°C DP and 80% rh ^k	17	3050	5/20	5 to 45 8 to 80		
A2	10 to 35	–12°C DP and 8% rh to 21°C DP and 80% rh ^k	21	3050	5/20	5 to 45 8 to 80 ¹		
АЗ	5 to 40	–12°C DP and 8% rh to 24°C DP and 85% rh ^k	24	3050	5/20	5 to 45 8 to 80		
A4	5 to 45	–12°C DP and 8% rh to	24	3050	5/20	5 to 45 8 to 80		

24°C DP and 90% rhk

Rack 48-1				
39				
38				
37				
36				
35 34				
33	spool0670.sdcc.bnl.gov			
32	spool0671.sdcc.bnl.gov			
31	spool0672.sdcc.bnl.gov			
30	spool0673.sdcc.bnl.gov			
29	spool0674.sdcc.bnl.gov			
28	spool0675.sdcc.bnl.gov			
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9	spool0694.sdcc.bnl.gov			
8	spool0695.sdcc.bnl.gov			
7	spool0696.sdcc.bnl.gov			

Test rack with (26) 1U Dell Power Edge R640 nodes Front view



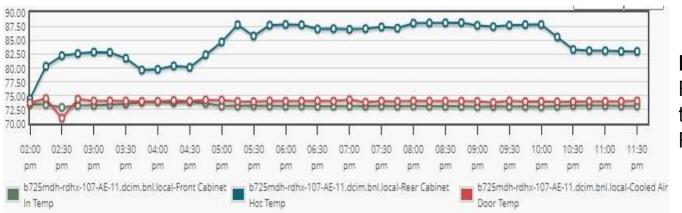


U Systems – Rear Door Heat Exchanger (RDHx) **Rear view**

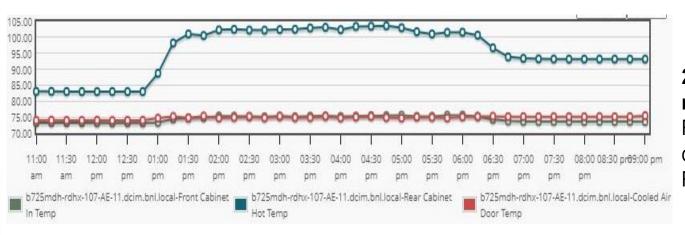


Simulating Higher Ambient Air Temperature

Reducing RDHx fan speed increases RDHx air inlet temperature (server output temperature) Rack air inlet and RDHx air outlet temperatures roughly unchanged



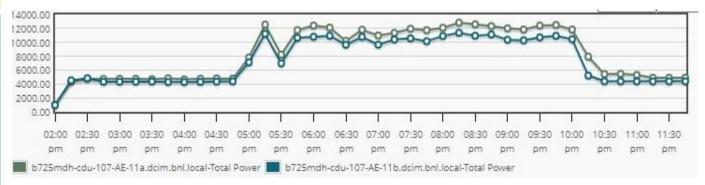
Normal RDHx mode Rack Inlet and RDHx discharge temp <76F RDHx coil inlet temp <90F



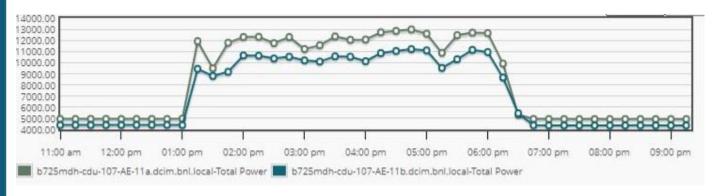
20% Fixed RDHx Fan Speed mode Rack Inlet and RDHx discharge temp <76F RDHx coil inlet temp 100F +

Effects on Total Rack Power Draw (cont'd)

Total rack power consumption roughly unchanged



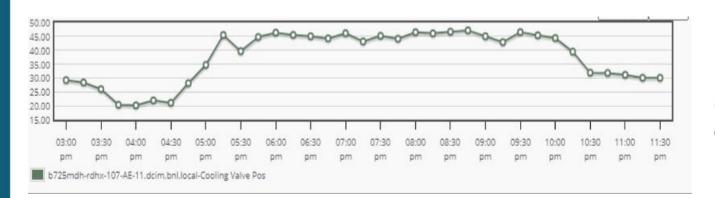
Normal RDHx mode
Overall power draw on
servers + RDHx ~ 13kW



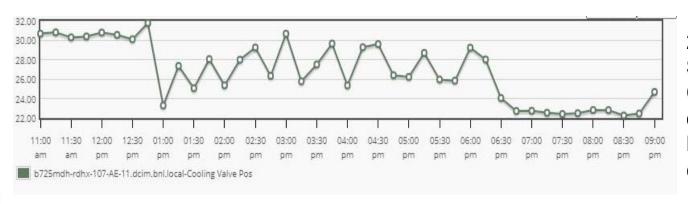
20% Fixed RDHx Fan
Speed mode
Overall power draw on
servers + RDHx ~ 13kW

Effects on Chilled Water Consumption

Decrease in chilled water consumptions with hotter servers

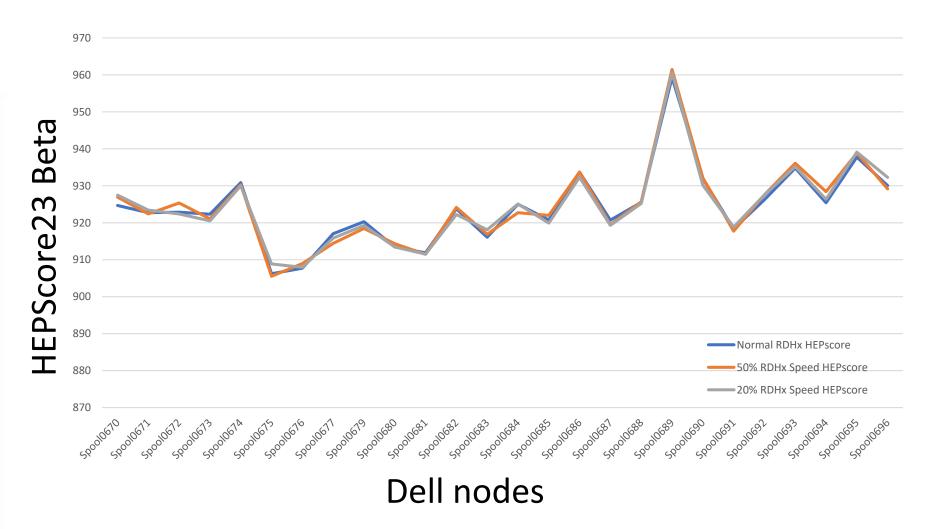


Normal RDHx mode
Chilled Water Valve
opened ~45% on average



20% Fixed RDHx Fan
Speed mode
Chilled Water Valve
opened ~30% on average
Less chilled water
consumption

Effects on Server HEPScore23



- HEPScore invariant to server temperature
- Some variability seen in HEPScore between servers of the same model/specs

Study Outcomes

- For a given server, HEPScore23 basically unchanged (1%-2%) over the tested temperature range.
- Some variation in HEPscore23 seen between servers of the same model/specs this is suspected to be due to CPU manufacturing variability.
- At the lowest (20% fixed) fan speeds, server exceeded vendor defined "standard operating temperature" specification" by 5°F, but still within the "extending operating temperature" envelope.
- Rack inlet and RDHx outlet air temperatures remained roughly constant for the test instances, suggesting ambient room temperature will remain unchanged and adjacent rack RDHx units were not picking up the load.
- Lowering the RDHx fan RPM resulted in reduced electric consumption for the RDHx, this will increase the duty life of the RDHx. But this is offset by relatively higher server fan power consumption due to increased RPM.

Future Research Work

- Instrumentation of RDHx chilled water outlet temperature
 - Would shed light on decreased chilled water consumption at high RDHx air inlet temperatures
 - Enable estimation of impact of higher ambient temperatures and higher chilled water supply temperature on chiller, circulating pumps and cooling tower efficiencies.
- Additional testing can be performed, by varying Chilled water supply temperature and chilled water system flow, to find the optimized 'sweet spot' with respect to the allowable server inlet temperature
- Obtain Data from building monitoring system and CPU usage. Using ML algorithm based on the workload intensity or carbon aware forecast, automate the cooling setpoint which may result in optimizing the chilled water system, lowering OPEX and PUE

QUESTIONS